

# SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

CUSTOMER: (客戶):志盛翔 DATE: (日期):2017-10-12

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: HP 400V180μF(φ25x30)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

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PREPARED (拟定)	CHECKED (审核)		APPROVAL (批准)	SIGNATURE (签名)
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MAN YUE ELECTRONICS	ELECTROLYTIC CAPACITOR	SAMXON
COMPANY LIMITED	SPECIFICATION HP SERIES	

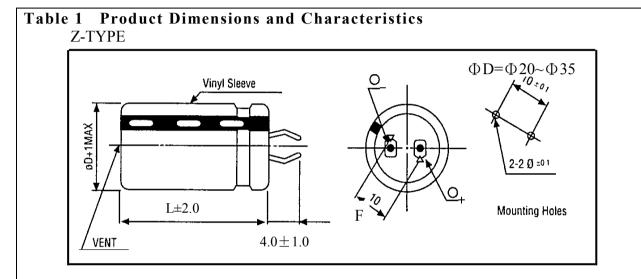


Table 1

No	SAMXON Part No.	WV (Vdc )	Cap. (µF)	Cap. tolerance	Temp. range(℃)	tanδ (120Hz, 20℃)	Leakage Current (µA,5min)	Max Ripple Current at 105°C 120Hz (A rms)	Load lifetime (Hrs)		nsion nm) F	Sleev e
1	EHP187M2GO30SZ**P	400	180	-20%~+20%	-25~105	0.20	804	0.92	2000	25X30	10±1.0	PET

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### 1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

Pa	rt Num	ber S	System								
1 2	3 4	56	3 7		89	[	10 11 12	2 131	4	1516	17
EG	S 1	0 5	5 IV		1 H		D 1 1	— т (	C	SA	Ρ
SERIE	S CAP	ACITAN	CE TO	L.	VOLTAGE		CASE SIZE	E TYP	E,	SAMXON PRODUCT LINE M	SLEEVE
											Ľ
Series	Cap(MFD)	Code	Tolerance (%)	Code	Voltage (W.V.)		Case Size	Feature (	Code	SAMXON Product L	ine
ESM EKF	0.1	104	±5	J	2	0D 0E	Diameter(	Radial bulk	RR	For internal use only	<
ESS EKS	0.22	224			4	0G	3 B 3.5 1 4 C 5 D	Ammo Tap	ina	(The product lines we have H,A,B,C,D,	
EGS EKM	0.22	224	±10	K	6.3	OJ	5 D 6.3 E		-	E,M or 0,1,2,3,4,5,9	).   <b> </b>
EKG EOM	0.33	334			8	0K 1A	6.3 E 8 F 10 G	2.0mm Pitch	Π		_
EZM EZS	0.47	474	±15	L	12.5	1B	12.5 I 13 J 13.5 V	2.5mm Pitch	тυ		
EGF ESF	1	105	±20	м	16 20	1C 1D	14 4	3.5mm Pitch	тν	Sleeve Material	Code
EGT EGK	<u> </u>	105			25	1E	14.5 A 16 K 16.5 7		$\vdash$		
EGE	2.2	225	±30	N	30 32	11 13	18 L	5.0mm Pitch	тс	PET	P
EGC	3.3	335	-40	w	35	1V	20 M	Lead Cut & F	Form	PVC	_
ERF	4.7	475	0		40 42	1G 1M	22 N 25 O 30 P 34 W 35 Q 40 R 42 4 45 6 51 S 63.5 T	СВ-Туре	СВ	FVC	If the sleeve material is PVC, there will be blank in seventeenth digit
ERR ERT	4./	4/5	-20 0	A	50	1H	34 W 35 Q	CE Turne	CE		sleev
ERE ERD	10	106	-20	с	57 63	1L 1J	40 R 42 4	СЕ-Туре			ema
ERH EBD ERA	22	226	+10	Ľ	71	1S	45 6 51 S	HE-Type	HE		teria
ERB	33	336	-20 +40	×	75 80	1T 1K	63.5 T	KD-Type	ĸD		IS P
EFA	1	+	-20 +50	s	85	1R	76 U 80 8 90 X 100 Z	FD-Type	FD		VC, t
ENH	47	476			90	19 2A	Len.(mm) Code		$\vdash$		here
ERY	100	107	-10 0	в	120	20	4.5 45 5 05	EH-Type	EH		Mil I
EAP	220	227	-10	v	125 150	2B 2Z	5.4 54 7 07	PCB Term	ial		e bla
EDP	1	$\left  \right $	+20	Ľ	160	2C	7.7 77 10.2 T2		sw		
EHP	330	337	-10 +30	Q	180 200	2P 2D	11 11 11.5 1A				SEVE
EKP EEP	470	477	-10	т	215	20	12 12 12.5 1B 13 13	Snap-in	sx		ntee
EFP ESP	2200	228	+50		220 230	2N	13.5 10		sz		률
EVP EGP	11		+10	E	250	23 2E	25 25 29.5 2J	Lug	SG		ġ;
EWR EWU	22000	229	-5 +15	F	275 300	2T 2I	20 20 25 25 29.5 2J 30 30 31.5 3A 35 35		05	L	
EWT	33000	339	-5 +20	G	310	2R	35 35 35.5 3E				
EWF	47000	479			315 330	2F 2U	50 50 80 80		06		
EWH	100000	10T	+20	R	350	20 2V	100 1L 105 1K		Т5		
EWB VSS			0 +30	0	360	2X	110 1M 120 1N	Screw	тө		
	150000	15T	0		375 385	2Q 2Y	130 1P 140 1Q				
VKM VRL	220000	22T	+50	$\left  - \right $	400	2G	150 1R 155 1E		D5		
VNH VZS VRF	330000	33Т	+5 +15	z	420	2M 2W	160 1S 165 1F 170 1T		D6		
VNF		+	+5 +20	D	500	2H	180 1U				
	1000000	10M	+10	Y	550 600	25 26	190 1V 200 2L 215 2A				
	1500000	15M	+50		630	2J	200 2L 215 2A 210 2M 220 2N 240 2Q 250 2S				
	2200000	22M	+10	н			240 2Q 250 2P				
	L	33M					260 2S 270 2T				
	3300000										

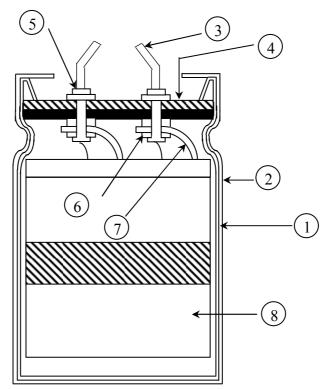
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### 3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material
1	Case	Aluminum case
2	Sleeve	PET
3	Terminal	Solder coated copper clad steel
4	Seal	Rubber-laminated bakelite
5	Rivet	Aluminum
6	Washer	Aluminum
7	Tab	Aluminum
8	Element	Aluminum foil & Electrolyte paper

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### 4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests is as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature:  $20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

### Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2

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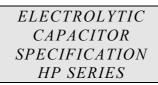


Table 2												
	ITEM				PEF	RFORM	IANC	E				
4.1	Rated voltage (WV) Surge voltage (SV)	WV (V.DC) SV (V.DC)	180 225	200 250	220 270	250 300	315 365	350 400	400 450	420 470	450 500	500 550
4.2	Nominal capacitance (Tolerance)	Measuring F Measuring V Measuring T <b><criteria< b="">&gt;</criteria<></b>	Shall be within the specified capacitance tolerance									
4.3	Leakage current	<ul> <li><condition> <ul> <li>Connecting the capacitor with a protective resistor (1k Ω ± 10 Ω) in series for 5 minutes, and then, measure Leakage Current.</li> </ul> </condition></li> <li><criteria> <ul> <li>Refer to table 1</li> </ul> </criteria></li> </ul>										
4.4	Condition> See 4.2, Norm Capacitance, for measuring frequency, voltage and temperature. Criteria> Refer to table 1											
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		<condition> A static load of 25N (2.5kgf) shall be applied to the lead wire terminal in the axis direction away from the capacitor body for 30s</condition>						
4.5	Terminal strength	<criteria> There shall be no intermi mechanical damage such</criteria>				circuit and t	here shall be n	
		< <u>Condition&gt;</u>						
		STEP Testing Tem	-					
			<u>+2</u>			ch thermal e	_	
		· · · · · · · · · · · · · · · · · · ·	$\frac{25)\pm 3}{25}$			ch thermal e		
			$\pm 2$			ch thermal e	•	
			$\frac{5\pm 2}{1+2}$			ch thermal e	-	
		5 20	$\pm 2$	111	ne to read	ch thermal e	quilibrium	
4.6	Temperature characteristics	The leakage current s b. At-40 ℃ (-25 ℃), imper following table:			-		e of the	
		Working Voltage (V)	10~25	35	50	63~100	160~500	
		Z-25℃/Z+20℃	6	6	4	3	8	
		Z-40°C/Z+20°C	15	15	15	15		
		Capacitance, tan $\boldsymbol{\delta}$ , and	Impedance	shall be	e measure	ed at 120Hz		

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4.7	Load life test	temp 2000 work time <criter The Lea Cap tan</criter 	erature of 1 +48/0 hours ing voltage) at atmosphe ia> characterist kage curren pacitance Ch	$05^{\circ}C \pm 2$ s. (The su ) Then the eric condi- <u>ic shall n</u> t	2 with DC bias vol am of DC and ripp e product should b tions. The result s neet the following Value in 4.3 shal Within $\pm 20\%$ o Not more than 20	l be satisfied	l ripple cu all not exc ours recov lowing tal	rrent for eed the rated ering
4.8	Shelf life test	for 100 Follow allowe Next t voltag tested <b><crit< b=""> The o Lea Cap tan App</crit<></b>	pacitors are 00+48/0 how ving this pe- ed to stabiliz- hey shall be- e applied for the character eria> characteristic kage current vacitance Ch bearance ark: If the characteristic bearance	ars. riod the o zed at roo e connect or 30min. eristics. c shall m t hange	capacitors shall be m temperature for ed to a series limit After which the c eet the following r Value in 4.3 shal Within $\pm 15\%$ o Not more than 13 There shall be no are stored more th	ing resistor(1k $\pm$ 1 capacitors shall be requirements. Il be satisfied	e test cha 00 Ω ) wit discharge discharge d value. olyte cage curre	mber and be th D.C. rated ed, and then, nt may
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4.9 Surge test	resistor. The capacitor shall be sub $\pm 5s$ , followed discharge of The test temperature shall $C_R$ :Nominal Capacitance ( <b><criteria></criteria></b> Leakage current Capacitance Change tan $\delta$ Appearance Attention:	<ul> <li>be 15~35°C.</li> <li>μ F)</li> <li>Not more than the specified value.</li> <li>Within ±15% of initial value.</li> <li>Not more than the specified value.</li> <li>There shall be no leakage of electrolyte</li> </ul>
4.10 Vibration test	perpendicular directions. Vibration frequency range Peak to peak amplitude Sweep rate <b>Criteria&gt;</b> After the test, the followin Appearance elect be le Inner No in construction No d	: 1.5mm : 10Hz ~ 55Hz ~ 10Hz in about 1 minute g items shall be tested: nechanical damage in terminal. No leakage of rolyte or swelling of the case. The markings shall
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		<condition></condition>	d d 4h C-11in dition				
		-	d under the following conditions: : 245±3°C				
		Soldering temperature	: 245±5°C				
		Dipping depth					
		Dipping speed	: 25±2.5mm/s				
		Dipping time	: 3±0.5s				
4.11	Solderability test	<criteria></criteria>					
	test	Coating quality	A minimum of 95% of the surface being immersed				
		$260\pm5$ °C for $10\pm1$ second the body of capacitor .	shall be immersed into solder bath at s or $400 \pm 10^{\circ}$ C for $3^{+1}_{-0}$ seconds to $1.5 \sim 2.0$ mm from e left under the normal temperature and normal fore measurement.				
		< <u>Criteria</u> > Leakage current	Not more than the specified value.				
		Capacitance Change	Within $\pm 10\%$ of initial value .				
	Resistance to	tan $\delta$	Not more than the specified value.				
4.12	solder heat	Appearance	There shall be no leakage of electrolyte				
	test						

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4.13 Change of temperature test	According oven, the (1)+20°C (2)Ratec (3)Ratec (1) to (3) <criteria< th=""><th>ure Cycle: g to IEC60384 condition acc Ter C l low tempera l high tempera )=1 cycle, tota current</th><th>4-4No.4.7 methods, cal cording as below: mperature ture(-40<math>^{\circ}</math>C) (-25<math>^{\circ}</math>C) ature (+105<math>^{\circ}</math>C) al 5 cycle meet the following req Not more than the Not more than the There shall be no le</th><th><math display="block">     \begin{array}{c c}       T \\                             </math></th><th>Value.</th></criteria<>	ure Cycle: g to IEC60384 condition acc Ter C l low tempera l high tempera )=1 cycle, tota current	4-4No.4.7 methods, cal cording as below: mperature ture(-40 $^{\circ}$ C) (-25 $^{\circ}$ C) ature (+105 $^{\circ}$ C) al 5 cycle meet the following req Not more than the Not more than the There shall be no le	$     \begin{array}{c c}       T \\                             $	Value.
4.14 Damp heat test	be exposed 40±2℃, t <criteria> Leakage o</criteria>	est: to IEC60384- l for $500 \pm 8$ h he characteris current ice Change	-4No.4.12methods, cap nours in an atmosphere stic change shall meet t Not more than the spe Within $\pm 20\%$ of init Not more than 120% of There shall be no leak	of 90~959 he followi ccified valu tial value . of the spec	%R H .at ng requirement. ue.
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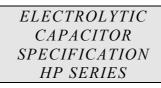
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	test	Diameter (mm)DC 022.4 or lessOver 22.4 <criteria>The vent shall operate with of pieces of the capacitor</criteria>		ous condition	ns such as a	flames or dispe	ersion
		<condition> The maximum permissible at 120Hz and can be appli Table-1 The combined value of D.0 rated voltage and shall no Frequency Multipliers:</condition>	ied at maxim	um operatin l the peak A	g temperat	ure	ed the
	Maximum permissible (ripple	Coefficient (Hz) Voltage (V)	60	120	1k	10~50k	
4.16	current)	10~100V	0.90	1.00	1.15	1.25	
		160~250V	0.80	1.00	1.25	1.47	
		315~500V	0.80	1.00	1.30	1.47	

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# 5.It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances					
	Cadmium and cadmium compounds					
Heavy metals	Lead and lead compounds					
Ticavy metals	Mercury and mercury compounds					
	Hexavalent chromium compounds					
	Polychlorinated biphenyls (PCB)					
Chloinated	Polychlorinated naphthalenes (PCN)					
organic	Polychlorinated terphenyls (PCT)					
compounds	Short-chain chlorinated paraffins(SCCP)					
	Other chlorinated organic compounds					
Brominated organic compounds	Polybrominated biphenyls (PBB)					
	Polybrominated diphenylethers(PBDE) (including					
	decabromodiphenyl ether[DecaBDE])					
	Other brominated organic compounds					
Tributyltin comp	oounds(TBT)					
Triphenyltin con	npounds(TPT)					
Asbestos						
Specific azo con	npounds					
Formaldehyde						
Polyvinyl chlorid	de (PVC) and PVC blevds					
Beryllium oxide						
Beryllium copp	er					
Specific phthalat	tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)					
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)					
Perfluorooctane	sulfonates (PFOS)					
Specific Benzotr	iazole					

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### **Attachment: Application Guidelines**

### **1.Circuit Design**

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at  $20^{\circ}$ C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
  - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
  - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
  - a) At higher frequencies capacitance and impedance decrease while tan  $\delta$  increases.
  - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid

The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

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### (1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

### (3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

- (2) Capacitors Connected in Series Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.
- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

### (2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

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<ul> <li>(4) Clearance for Case Mounted Pressure Relief vents</li> <li>Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.</li> <li>\$\phi 6.3 \circ \phi 16mm:2mm minimum, \$\phi 18 \circ \phi 35mm:3mm minimum, \$\phi 40mm or greater:5mm minimum.</li> </ul>
<ul><li>(5) Clearance for Seal Mounted Pressure Relief Vents</li><li>A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.</li></ul>
(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
<ul> <li>(7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.</li> </ul>
<ul> <li>(8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.</li> </ul>
<ol> <li>1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows.</li> <li>(1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths</li> <li>(3) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.</li> </ol>
1.7 The Product characteristic should take the sample as the standard.
<ul><li>1.8 Capacitor Sleeve The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.</li></ul>
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

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### 2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about  $1k \Omega$ .
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately  $1k \Omega$ .
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- \* (1) Verify the correct capacitance and rated voltage of the capacitor.
- \* (2) Verify the correct polarity of the capacitor before inserting.
- \* (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
  (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

### 2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400  $^\circ$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

### 2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

### 2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

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### 2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- \* (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- \* (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- . Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- \* (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- \* (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

### **3.** Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- \* (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- \* (2) Direct contact with water, salt water, or oil.
- \* (3) High humidity conditions where water could condense on the capacitor.

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- \* (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- \* (5) Exposure to ozone, radiation, or ultraviolet rays.
- \* (6) Vibration and shock conditions exceeding specified requirements.

### 3.2 Electrical Precautions

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

### 4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures. If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water. If electrolyte or gas is ingested by month, gargle with water. If electrolyte contacts the skin, wash with soap and water.

### 5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a  $1000 \Omega$ , current limiting resistor for a time period of 30 minutes .

### 5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

### 6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

- \* Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.
- \* Dispose of as solid waste.

NOTE: Local laws may have specific disposal requirements, which must be followed.

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